3-215316-5 ACTIVE

AMPMODU | AMPMODU HV-100/HV-190

TE Internal #: 3-215316-5

PCB Mount Receptacle, Vertical, Board-to-Board, 35 Position, 2.54

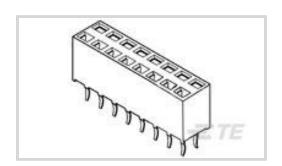
mm [.1 in] Centerline, Tin, Through Hole - Solder, Signal,

AMPMODU HV-100/HV-190

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: **35**Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	35
Number of Rows	2
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Green

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.63 mm[.024 in]
PCB Contact Termination Area Plating Material Thickness	2.5 – 4 μm[98.425 – 157.48 μin]
Mating Pin Diameter	.63 mm[.024 in]



Contact Shape & Form	Square
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	2.5 – 4 μm[98.425 – 157.48 μin]
Contact Type	Socket
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester - GF
Dimensions	
Connector Height	6.2 mm[.244 in]
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.6 mm[.062 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C, -55 – 105 °C[-85 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Tray



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Also in the Series | AMPMODU HV-100/HV-190



Customers Also Bought

PCB Mount Receptacle, Vertical, Board-to-Board, 35 Position, 2.54 mm [.1 in] Centerline, Tin, Through Hole - Solder, Signal, AMPMODU HV-100/HV-190

















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_3-215316-5_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_3-215316-5_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_3-215316-5_E.3d_stp.zip

English

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Product Specifications

Connector System HV-100

German

Product Specification

German